

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Ranish et al.	Group Art Unit: Unknown
Application No: Unknown Confirmation No: Unknown	Examiner: Unknown
Filed: Herewith	Attorney Docket No: 008341 USA/CPS/IBSS/LAP
Title: THERMALLY MATCHED SUPPORT RING FOR SUBSTRATE PROCESSING CHAMBER	January 6, 2003 San Francisco, California

INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

Attached hereto is a PTO-1449 form listing documents believed relevant to the subject application. It is respectfully requested that these documents be considered by the Examiner and an initialed copy of the form be returned to the undersigned.

Applicant believes this Information Disclosure Statement should be considered by the Office because it is being filed before the mailing of a first Office Action on the merits.

It is believed that no fee is due for the filing of this Information Disclosure Statement. However, if any fee is due, the Commissioner is hereby authorized to charge payment of any such fees to Deposit Account No. 10-0258.

Also, if any Petition is required for the filing of this Information Disclosure Statement, such Petition is requested herein.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as express mail in an envelope addressed to: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or facsimile transmitted to the U.S. Patent and Trademark Office at (703) ___ on the date shown below.

By: 

Date: FEB. 5, 2004

It is believed that this disclosure complies with the requirements of 37 C.F.R. §§ 1.56, 1.97, and 1.98, and the Manual of Patent Examining Procedures §707.05(b). If for some reason the Examiner considers otherwise, it is respectfully requested that the undersigned be called so that any deficiencies can be remedied.

Except for US patents and published applications, a copy of each document is enclosed.

Some of the documents may have markings thereon. No significance is meant to be attached to the markings.


With regard to any translations which may be provided herewith, the undersigned does not know how the translations were made, or by whom the translations were made. Therefore, no representation is being made as to the accuracy of any translation.

These documents are not necessarily analogous.

Respectfully submitted,
JANAH & ASSOCIATES, P.C.

Date: 1/16/2004

By:


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Encl.

